COMSOL CONFERENCE BOSTON 2013

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IMPORTANT DATES

JUN 21 Early bird abstract submission, submit and save!

AUG 2 Final abstract submission
AUG 16 Abstract approval notification

SEP 13 Paper, poster and author registration deadline

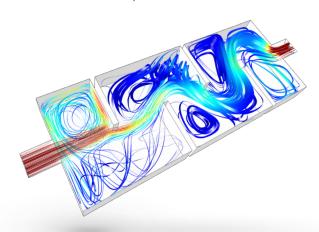
SUGGESTED TOPIC AREAS

- » Acoustics and Vibrations
- » Batteries and Fuel Cells
- » Bioscience and Bioengineering
- » Chemical Reaction Engineering
- » Computational Fluid Dynamics
- » Education
- » Electrochemistry
- » Geophysics
- » Heat Transfer & Phase Change
- » Electromagnetics
- » MEMS & Piezoelectric Devices
- » Microfluidics
- » Multiphysics

- » Nanotechnology
- » Numerical Methods
- » Optimization
- » Optics, Photonics & Plasmonics
- » Plasma Physics, EHD & MHD
- » Porous Media Flow
- » Ouantum Mechanics
- » RF & Microwaves
- » Semiconductor Devices
- » Sensors and Actuators
- » Structural Mechanics
- » Transport Phenomena

PROGRAM HIGHLIGHTS

Minicourses, Panel Discussions, Exhibition, Keynote Speakers, Poster Session and Paper Presentations



SUBMIT ABSTRACT BY JUNE 21 AND SAVE

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